



### THERMOPLASTIC POLYESTER RESIN

Common features of Rynite® thermoplastic polyester include mechanical and physical properties such as excellent balance of strength and stiffness, dimensional stability, creep resistance, heat resistance, high surface gloss and good inherent electrical properties at elevated temperature. It can be processed over a broad temperature range and has excellent flow properties.

Rynite® thermoplastic polyester resins are typically used in demanding applications in the automotive, electrical and electronics, appliances where they successfully replace metals and thermosets, as well as other thermoplastic polymers.

Rynite® 935 NC010 is a 35% mica/glass reinforced modified polyethylene terephthalate resin with low warpage and excellent electrical properties.

#### Product information Resin Identification PET-(MD+GF)3 ISO 1043 Part Marking Code >PET-(MD+GF)35< ISO 11469 Rheological properties Moulding shrinkage, parallel 0.3 % ISO 294-4, 2577 Moulding shrinkage, normal ISO 294-4, 2577 0.7 % Typical mechanical properties Tensile modulus 10200 MPa ISO 527-1/-2 Tensile stress at break, 5mm/min 85 MPa ISO 527-1/-2 Tensile strain at break, 5mm/min 2 % ISO 527-1/-2 Flexural modulus 9100 MPa ISO 178 Compressive strength 140 MPa ISO 604 Tensile creep modulus, 1h 9350 MPa ISO 899-1 Tensile creep modulus, 1000h 7690 MPa ISO 899-1 Charpy impact strength, 23°C 25 kJ/m<sup>2</sup> ISO 179/1eU Charpy impact strength, -30°C 20 kJ/m<sup>2</sup> ISO 179/1eU Charpy notched impact strength, 23°C 6 kJ/m<sup>2</sup> ISO 179/1eA Charpy notched impact strength, -30°C 4 kJ/m<sup>2</sup> ISO 179/1eA 75 Hardness, Rockwell, M-scale ISO 2039-2 Hardness, Rockwell, R-scale 115 ISO 2039-2 Poisson's ratio 0.34 Thermal properties Melting temperature, 10°C/min 252 °C ISO 11357-1/-3 200 °C Temperature of deflection under load, 1.8 MPa ISO 75-1/-2 Temperature of deflection under load, 0.45 MPa 235 °C ISO 75-1/-2 Vicat softening temperature, 50°C/h 50N 205 °C **ISO 306** Coeff. of linear therm. expansion, parallel, -40-23°C 26 E-6/K ISO 11359-1/-2 16 E-6/K ISO 11359-1/-2 Coefficient of linear thermal expansion (CLTE), parallel Coeff, of linear therm, expansion, normal, -40-23°C 53 E-6/K ISO 11359-1/-2 Coefficient of linear thermal expansion (CLTE), 52 E-6/K ISO 11359-1/-2 normal

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0.26 W/(m K)

ISO 22007-2

Revised: 2025-04-22 Source: Celanese Materials Database

Thermal conductivity, flow





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Thermal conductivity of melt	0.32	W/(m K)	ISO 22007-2
Effective thermal diffusivity, flow	1.4E-7	m²/s	ISO 22007-4
Specific heat capacity of melt	1790	J/(kg K)	ISO 22007-4
RTI, electrical, 0.75mm	140	°C	UL 746B
RTI, electrical, 1.5mm	140	°C	UL 746B
RTI, electrical, 3.0mm	140	°C	UL 746B
RTI, impact, 0.75mm	140	°C	UL 746B
RTI, impact, 1.5mm	140	°C	UL 746B
RTI, impact, 3.0mm	140	°C	UL 746B
RTI, strength, 0.75mm	140	°C	UL 746B
RTI, strength, 1.5mm	140	°C	UL 746B
RTI, strength, 3.0mm	140	°C	UL 746B

### Flammability

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Burning Behav. at 1.5mm nom. thickn.	НВ	class	IEC 60695-11-10
Thickness tested	1.5	mm	IEC 60695-11-10
UL recognition	yes		UL 94
Burning Behav. at thickness h	HB	class	IEC 60695-11-10
Thickness tested	0.75	mm	IEC 60695-11-10
UL recognition	yes		UL 94
Oxygen index	21	%	ISO 4589-1/-2
Glow Wire Flammability Index, 0.75mm	775	°C	IEC 60695-2-12
Glow Wire Flammability Index, 1.5mm	775	°C	IEC 60695-2-12
Glow Wire Flammability Index, 3.0mm	825	°C	IEC 60695-2-12
Glow Wire Ignition Temperature, 0.75mm	800	°C	IEC 60695-2-13
Glow Wire Ignition Temperature, 1.5mm	800	°C	IEC 60695-2-13
Glow Wire Ignition Temperature, 3.0mm	850	°C	IEC 60695-2-13
Glow Wire Temperature, No Flame, 0.75mm	750	°C	IEC 60335-1
Glow Wire Temperature, No Flame, 1mm	750	°C	IEC 60335-1
Glow Wire Temperature, No Flame, 1.5mm	750	°C	IEC 60335-1
Glow Wire Temperature, No Flame, 3mm	850	°C	IEC 60335-1
FMVSS Class	В		ISO 3795 (FMVSS 302)
Burning rate, Thickness 1 mm	<80	mm/min	ISO 3795 (FMVSS 302)

### **Electrical properties**

· ·		
Relative permittivity, 100Hz	4.5	IEC 62631-2-1
Relative permittivity, 1MHz	4.1	IEC 62631-2-1
Dissipation factor, 100Hz	300 E-4	IEC 62631-2-1
Dissipation factor, 1MHz	140 E-4	IEC 62631-2-1
Volume resistivity	1E13 Ohm.m	IEC 62631-3-1
Surface resistivity	1E14 Ohm	IEC 62631-3-2
Electric strength	39 kV/mm	IEC 60243-1
Comparative tracking index	300	IEC 60112

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### Physical/Other properties

Humidity absorption, 2mm	0.13 %	Sim. to ISO 62
Water absorption, 2mm	0.83 %	Sim. to ISO 62
Density	1580 kg/m³	ISO 1183
Density of melt	1320 kg/m <sup>3</sup>	

### **VDA Properties**

Fogging, G-value (condensate)

0.1 mg ISO 6452

### Injection

Drying Recommended	yes	
Drying Temperature	120	°C
Drying Time, Dehumidified Dryer	4 - 6	
Processing Moisture Content	≤0.02 <sup>[1]</sup>	%
Melt Temperature Optimum	285	°C
Min. melt temperature	280	°C
Max. melt temperature	300	°C
Screw tangential speed	≤0.2	m/s
Mold Temperature Optimum	110	°C
Min. mould temperature	100	-
Max. mould temperature	120 <sup>[2]</sup>	°C
Hold pressure range	≥80	MPa
Hold pressure time	4	s/mm
Back pressure	As low as	MPa
	possible	
Ejection temperature	170	°C

[1]: At levels above 0.02%, strength and toughness will decrease, even though parts may not exhibit surface defects.

[2]: (6mm - 1mm thickness)

#### Characteristics

Processing Injection Moulding

Delivery form Pellets

Additives Release agent Special characteristics Low Warpage

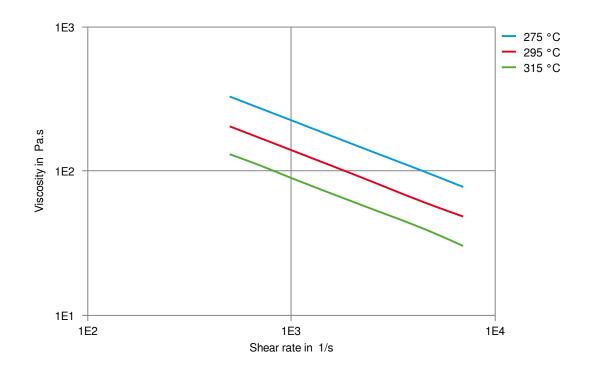
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# Rynite® 935 NC010 THERMOPLASTIC POLYESTER RESIN

Viscosity-shear rate



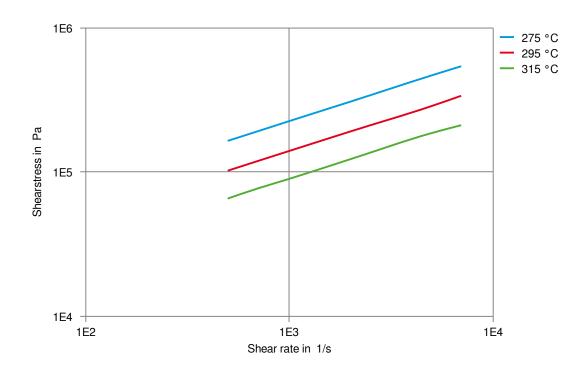
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# Rynite® 935 NC010 THERMOPLASTIC POLYESTER RESIN

Shearstress-shear rate



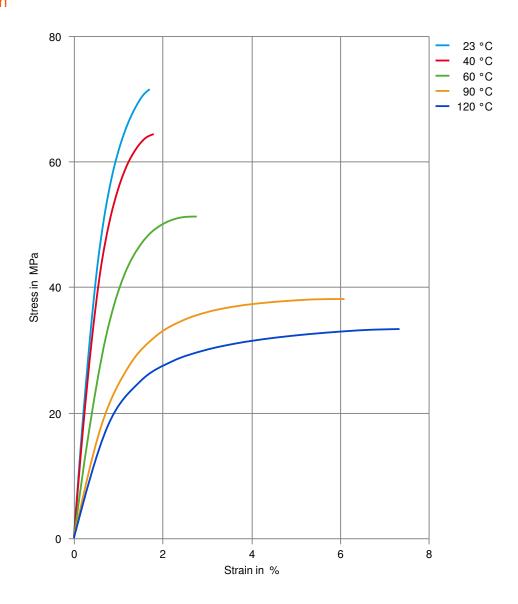
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### THERMOPLASTIC POLYESTER RESIN

### Stress-strain



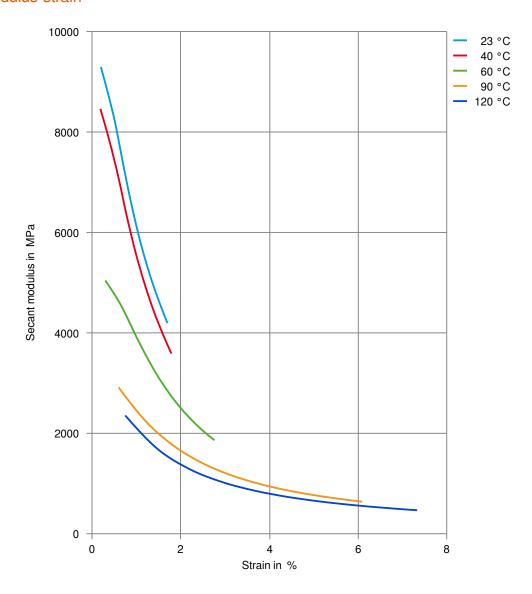
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### THERMOPLASTIC POLYESTER RESIN

### Secant modulus-strain



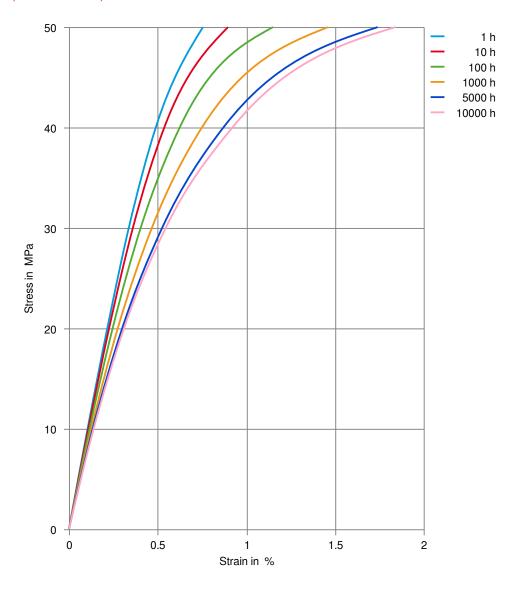
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### THERMOPLASTIC POLYESTER RESIN

Stress-strain (isochronous) 23°C



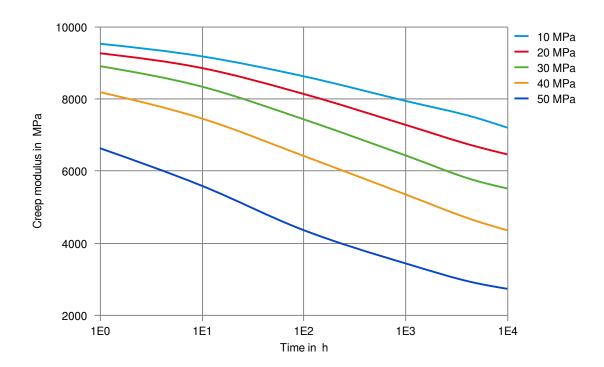
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# Rynite® 935 NC010 THERMOPLASTIC POLYESTER RESIN

Creep modulus-time 23°C



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Revised: 2025-04-22 Source: Celanese Materials Database

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